SuperM.O.L.E.® Gold 2

- 6-channel value-packed thermal profiling workhorse most often relied upon for in-transit thermal profiling Quality Assurance.
- Profile for recipe generation, golden boards and oven verification, all with the same tool
- Multi-run, 1.5 million data point memory means your not tethered to the PC for ongoing profile runs
- Easy to use - separate On/Off and Record buttons, direct USB for setup, download and charging
- 14 LED's keep you informed of M.O.L.E.® and sensors mode and health
- Takes full advantage of M.O.L.E.® MAP Software, pallets, and sensors

• Elevates profiling precision of large complex boards to 20 assembly locations to satisfy OEM and R&D demands

• Easy of use - Thermocouples organized into 4 gangs of 5 channels, nano-mini adapters available

• Patented “OK” button provides instant profile validation: Engineer sets Slope, Soak, TAL and Peak specs in M.O.L.E.® MAP. Operator presses “OK” button for instant Go/No-Go assurance by Green/Red LED.

• Three-module design with M.O.L.E.®, I/O Module and Power Pack for interchangeable flexibility

• Multi-run, 1.5 million data point memory enables faster sample rates and longer runs

• Real-Time Wireless RF Compatible

• Perfect 3-channel entry-Level Profiler
• Value-packed - High level of similarity to our 6 and 20 channel models with the same controls
• Profiles Hot, Cold and Sensitive components on your PCB
• M.O.L.E.® readiness indicators show battery and internal temperature are good for a run
• Operator Go/No-Go function is achieved with Patented “OK” button for instant profile validation
• Powers OvenCHECKER™ too!
• 3-channel profiling solution that enables Quality Assurance measurement during Metallization and Lamination Press Photo Voltaic processes
• 16mm/0.7” polished Stainless Steel Thermal Barrier
• Stainless Steel Sheathed Type K Mini Thermocouples
• Optional Compression Shell for 0.7” barrier available
• 96-run Memory and 70 hours of logging at 0.1 second rate
• M.O.L.E.® MAP 3’s Solar Metallization Environment enables V-M.O.L.E.® Solar’s “OK” button with Soak, Peak and TAL specifications
• M.O.L.E.® Readiness Indicators show battery and internal temperature are good for a run

• Guarantees the wave solder machine is performing the product recipe, every day
• Use as a physically stable alternative to a “Golden Board” as a first-off at the beginning of every shift (Go/No-Go readiness)
• Process Sensors quantify Parallelism, Dwell Time in wave(s) Immersion Depth and Conveyor Speed
• Replaceable Test Coupon measures solder, top and bottom-side temperatures
• For 6-channel SuperM.O.L.E.® Gold 2 & M.O.L.E.® MAP 3

WaveRIDER® Data Table:
This table is specialized for wave solder machine applications. The Group Parameters on the data sheet are color coded so when they are viewed on other Page Tabs they can be easily associated with the Label Parameters.

Features:
1. Pre-heat Parameters and Conveyor speed.
2. Chip Wave Parameters (Blank column if there is no chip wave).
3. Solder Wave Parameters.
5. Overall Coupon Parameters.
• Industry standard 6-channel convection reflow oven verification platform
• Superior alternative to ‘Golden Board’ as a first-off [thousands of runs]
• Verifies Heat Flow and Temperatures per zone across the oven plus Conveyor Speed
• Provides SPC-driven Go/No-Go oven readiness to the process engineer, operators and maintenance technicians
• Comes in 6.6”/168mm; 12”/305mm; & 18”/458mm + custom widths
• For 6-channel SuperM.O.L.E.® Gold 2 & M.O.L.E.® MAP 3
OvenRIDER® Data Table:

This table specialized for reflow oven applications. The Group Parameters are color coded so when they are viewed on other Page Tabs they can be easily associated with the Label Parameters.

Features:

1. Oven Summary data
2. M.O.L.E.® Status
3. Individual Temperature and Process Delta Zone Data
3-channel reflow oven recipe verification platform
Perfect choice if you must delegate Go/No-Go decisions to multiple operators
The 3-channel V.M.O.L.E.® interprets 3 FR4-simulating sensors on the pallet’s leading edge
ECD-exclusive ‘OK Button” makes quick work of determining if oven is in or out of Spec
You Specify Ramp, Soak, TAL and Peak, make a Run then press the OK button to Verify specs

Create a Target-10™ specification file using the OvenCHECKER™:

- A simple color “Go/No-Go” test criteria
- Analog gauges for intuitive data interpretation
- Drill down Data for engineering analysis
- Configurability, so you can delegate decision-making

"Verify" your process using the OvenCHECKER™ by pressing the OK button.
• With MAP 3 any ECD sensor package input to any ECD M.O.L.E.® operates within a unique ‘Environment’ attuned to the profiling job at hand – all within the same program!

• WaveRIDER® NL2, OvenRIDER® NL2 and other platforms all operate within a unique M.O.L.E.® MAP Environment

• Special Profile Tab sets up the M.O.L.E.®’s patented “OK” button for Target-10, Bake-S, and Relative Humidity, etc.

• Flexible: Interactive Prediction is a great assist for recipe development. You can make quick adjustments to a profile just made or any run in any MAP Directory

• Robust: Process documentation complete with Oven and Solder Paste Databases you can easily add to, Preferences can be set once or customized to various product and production lines.

• Quickly pictures spray flux top side penetration and pattern uniformity to ensure proper setup and maintenance
• Ensure proper deoxidation and whetting throughout the width and length of wave soldered products
• Load on conveyor just like product and retrieve prior to preheater if a product recipe is active
• Sprayed flux through a sandwiched through-hole mesh makes an easily discernible and comparable signature on the test paper to make your machine adjustments
Continuously monitors the quality of PCB assemblies passing through your convection reflow oven...24 hours a day...365 days a year

Automatically reports any out-of-specification problems & trends before product quality is negatively affected

Records while comparing the Golden Profile against prevailing production conditions and archives for later recall, to exact serial number [with bar code option] for board level audit capability

Automatic statistical process control (SPC) establishes quality specifications & alerts you to out-of-control trends during operation

• J-STD Performance – Achieves more than just compliance with innovative regeneration
• Market leading recovery time of <3 minutes provides constant access to your stored parts
• Designed by trusted electronics innovator, ECD, and quality-built in the U.S.A.
• Selection of volume sizes to suit your needs
• Industry 4.0 Ready - Integrated network tracks events from all SmartDRY™ cabinets for access to data on connected devices.
• Immediate visual confirmation of dry storage status

Web: www.smartdry.com
Available in a wide variety of insulation types and temperature ratings to suit your application

We stock and can supply a full range of K-type thermocouples with PFA (Teflon®), glass, glass with overbraid and stainless/inconel sheath in your length and wire diameter

Micro, Nano and Mini connector styles available

ECD sells only special-limits-of-error grade thermocouple wire

Maintain the integrity of your measurements by replacing thermocouples at the first sign of nicks, kinks or severed junction

Can be selected and purchased on our Super Store as well

• Adapts mini-terminated K-Type thermocouples to ECD Micro Gold & Nano styles.
• One-Piece and individual channel adapters.
• Available in Teflon and Glass wire insulations for high-temp lead-free work. The glass wire and high temp mini connectors are rated to 900F/482C.
- T/C Fiberglass Sleewing Organizer
- High Temp Solder Sample [Sn05Pb93]
- Aluminum T/C Tape (Roll & 0.5" x 1" pieces)
- Polymide [Kapton] T/C Tape (Roll & 0.25" x 1" pieces)
- Instant Adhesive
- Takpak Spray Accelerator
• A precision reusable instrument with excellent thermal isolation
• Non-destructive attachment – use when you can’t spare a profile board from the lot
• Clamp to trailing edge of PCB or ECD Board Carrier™
• Precisely set and lock angle and span to position tip onto any component or lead, including fine pitch

Reflow Profiling

- The Side Rider™ platform can be used alone for narrow rail widths or with an "Outrigger"; an expandable rugged, metal frame with scissors action extension.
- REFLOW RIDER™ is built of high quality materials, for reliable operation and long life. The side rails, arms and support deck are hard-anodized aluminum. The side rails are clear anodized aluminum. All fasteners are stainless steel.

Wave Soldering

- The E-Z RIDER™ adjusts to the exact width of your circuit board in seconds. Scissor out the side rails to match the width of your board, and lock them in place with the turn of a screw. Place your profiler on the carrier, where it is securely held by two arms and a backstop, and insert its titanium side rails into the finger conveyor.

Profiling...Easier than Ever With A Versatile Board Carrier™
Our high quality Board Carriers securely hold small to medium sized circuit boards of almost any shape and up to six Temp-probes™ for thermal profiling.

• Your M.O.L.E.®’s lifeline to longevity. Barriers enable in-transit profiling and we've got a wide range of models for uses you may not have thought of.
• Replace an old kit barrier
• Upgrade to keep the M.O.L.E.® cooler for longer or hotter process specs
• Expand M.O.L.E.® use to multiple process heating applications in your plant (curing, coating, treating)
• A different thermal barrier and thermocouples stretch your profiler’s value
• Time at Temperature and vertical above belt clearance drive the thermal barrier selection for your application